

Description

The UPA2752GR-E1-A uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

D1_{D1}_{D2}_{D2} S1_{G1}_{S2</sup>_{G2} SOP-8}

General Features

V_{DS} = 30V I_D = 8A

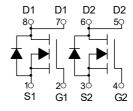
 $R_{DS(ON)} < 19m\Omega$ @ $V_{GS}=4.5V$

Application

Battery protection

Load switch

Uninterruptible power supply



Dual N-Channel MOSFET

Package Marking and Ordering Information

| Product ID | Pack | Marking | Qty(PCS) |
|----------------|-------|---------------|----------|
| UPA2752GR-E1-A | SOP-8 | 4842 XXX YYYY | 3000 |

Absolute Maximum Ratings@T_j=25°C(unless otherwise specified)

| Symbol | Parameter | Rating | Units | |
|--------------------------------------|---|-------------|-------|--|
| V _{DS} | Drain-Source Voltage | 30 | V | |
| V _G S | Gate-Source Voltage | <u>+</u> 20 | V | |
| I _D @T _A =25°C | Drain Current, V _{GS} @ 4.5V ³ | 8 | А | |
| I _D @T _A =70°C | Drain Current, V _{GS} @ 4.5V ³ | 5.8 | Α | |
| Ідм | Pulsed Drain Current ¹ | 37 | А | |
| P _D @T _A =25°C | Total Power Dissipation | 1.5 | W | |
| Тѕтс | Storage Temperature Range | -55 to 150 | °C | |
| TJ | Operating Junction Temperature Range | -55 to 150 | °C | |
| Rthj-a | Maximum Thermal Resistance, Junction- ambient ³ | 85 | °C/W | |



Electrical Characteristics (T_J=25 °C, unless otherwise noted)

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit | |
|----------------------------------|--|---|------|-------|------|-------|--|
| BV _{DSS} | Drain-Source Breakdown Voltage | V_{GS} =0V , I_D =250uA | 30 | | | V | |
| $\triangle BV_{DSS}/\triangle T$ | BVDSS Temperature Coefficient | Reference to 25°C, I _D =1mA | | 0.034 | | V/°C | |
| R _{DS(ON)} | Static Drain-Source On-Resistance ² | V _{GS} =10V , I _D =7A | | 17 | 19 | mΩ | |
| | | V _{GS} =4.5V , I _D =4A | | 22 | 28 | | |
| $V_{GS(th)}$ | Gate Threshold Voltage | \\ -\\ -250\ | 1.2 | | 2.5 | V | |
| $\triangle V_{GS(th)}$ | V _{GS(th)} Temperature Coefficient | $V_{GS}=V_{DS}$, $I_D=250uA$ | | -5.8 | | mV/°C | |
| | Drain-Source Leakage Current | V _{DS} =24V , V _{GS} =0V , T _J =25°C | | | 1 | uA | |
| I _{DSS} | | V _{DS} =24V , V _{GS} =0V , T _J =55°C | | | 5 | uA | |
| I _{GSS} | Gate-Source Leakage Current | $V_{GS}=\pm 20V$, $V_{DS}=0V$ | | | ±100 | nA | |
| gfs | Forward Transconductance | V _{DS} =5V , I _D =7A | | 6 | | S | |
| R_g | Gate Resistance | V _{DS} =0V , V _{GS} =0V , f=1MHz | | 2.5 | | Ω | |
| Qg | Total Gate Charge (4.5V) | | | 6 | | | |
| Q _{gs} | Gate-Source Charge | V _{DS} =15V , V _{GS} =4.5V , I _D =7A | | 2.5 | | nC | |
| Q_{gd} | Gate-Drain Charge | | | 2.1 | | | |
| T _{d(on)} | Turn-On Delay Time | | | 2.4 | | | |
| T _r | Rise Time | V_{DD} =15V , V_{GS} =10V , R_{G} =3.3 Ω | | 7.8 | | | |
| $T_{d(off)}$ | Turn-Off Delay Time | I _D =7A | | 22 | | ns | |
| T _f | Fall Time | | | 4 | | | |
| C _{iss} | Input Capacitance | | | 572 | | | |
| Coss | Output Capacitance | V _{DS} =15V , V _{GS} =0V , f=1MHz | | 80 | | pF | |
| C _{rss} | Reverse Transfer Capacitance | | | 65 | | | |

Diode Characteristics

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit |
|-----------------|--|---|------|------|------|------|
| Is | Continuous Source Current ^{1,5} | V =V =0V Force Current | | | 7.3 | Α |
| I _{SM} | Pulsed Source Current ^{2,5} | V _G =V _D =0V , Force Current | | | 37 | Α |
| V_{SD} | Diode Forward Voltage ² | V _{GS} =0V , I _S =1A , T _J =25°C | | | 1.2 | V |
| t _{rr} | Reverse Recovery Time | | | 20 | | nS |
| Qrr | Reverse Recovery Charge | IF=7A , dI/dt=100A/μs , T _J =25°C | | 1.1 | | nC |

Note

- 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%
- 3. The EAS data shows Max. rating . The test condition is V_{DD} =25V, V_{GS} =10V, L=0.1mH, I_{AS} =21A
- 4.The power dissipation is limited by 150°C junction temperature
- 5. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



Typical Characteristics

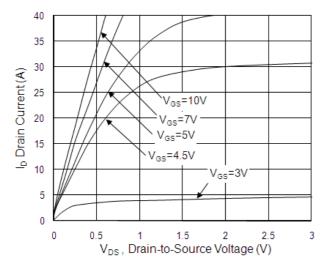


Fig.1 Typical Output Characteristics

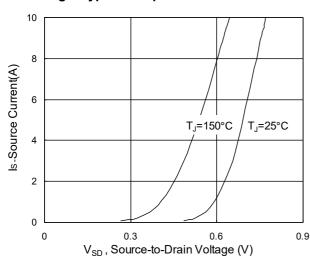


Fig.3 Forward Characteristics Of Reverse

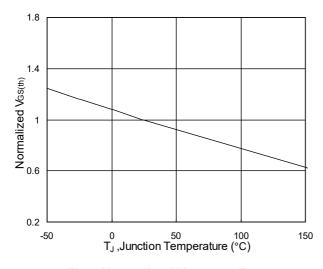


Fig.5 Normalized $V_{GS(th)}$ vs. T_J

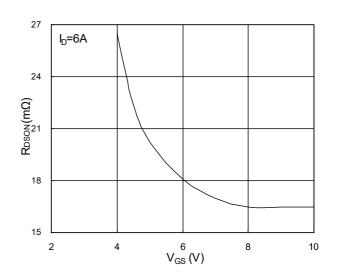


Fig.2 On-Resistance vs. G-S Voltage

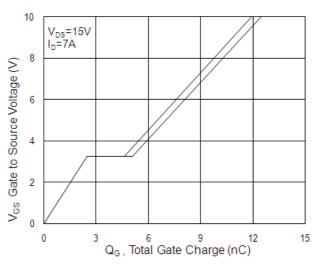


Fig.4 Gate-Charge Characteristics

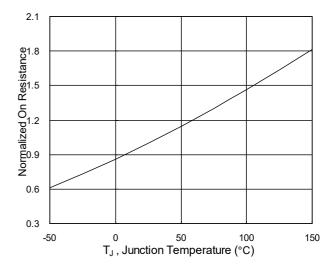
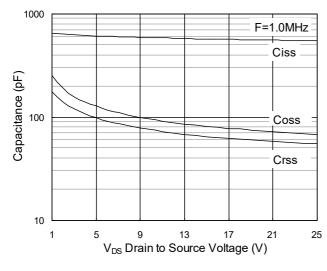


Fig.6 Normalized R_{DSON} vs. T_J





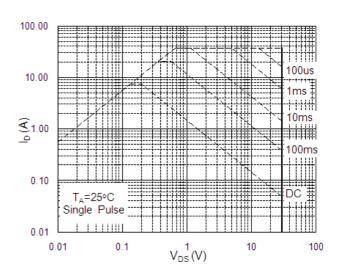


Fig.7 Capacitance

Fig.8 Safe Operating Area

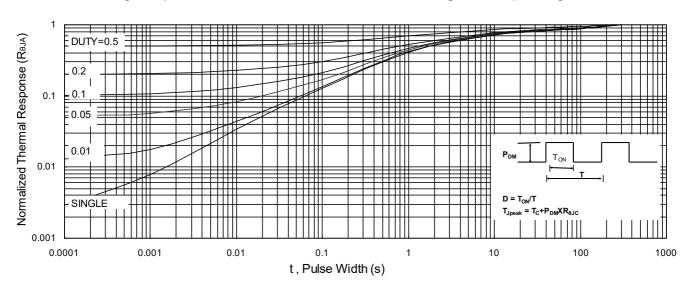


Fig.9 Normalized Maximum Transient Thermal Impedance

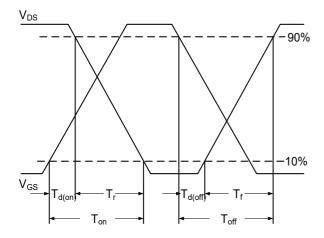


Fig.10 Switching Time Waveform

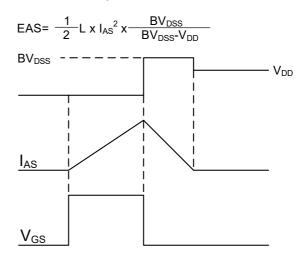
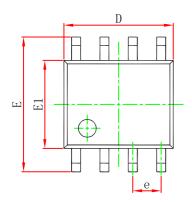
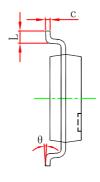


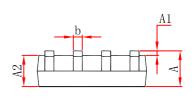
Fig.11 Unclamped Inductive Switching Waveform



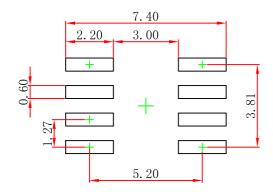
SOP-8 Package Outline Dimensions







| Symbol | Dimensions In Millimeters | | Dimensions In Inches | | |
|--------|---------------------------|--------|----------------------|--------|--|
| | Min | Max | Min | Max | |
| A | 1. 350 | 1.750 | 0.053 | 0.069 | |
| A1 | 0.100 | 0. 250 | 0.004 | 0.010 | |
| A2 | 1.350 | 1.550 | 0.053 | 0.061 | |
| b | 0.330 | 0.510 | 0.013 | 0.020 | |
| c | 0.170 | 0.250 | 0.007 | 0.010 | |
| D | 4.800 | 5.000 | 0.189 | 0. 197 | |
| e | 1. 270 (BSC) | | 0.050 (BSC) | | |
| E | 5.800 | 6. 200 | 0.228 | 0. 244 | |
| E1 | 3.800 | 4.000 | 0.150 | 0. 157 | |
| L | 0.400 | 1. 270 | 0.016 | 0.050 | |
| θ | 0° | 8° | 0° | 8° | |



- Note:
 1.Controlling dimension: in millimeters.
- 2.General tolerance:± 0.05mm.
 3.The pad layout is for reference purposes only.



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